TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOSVI)

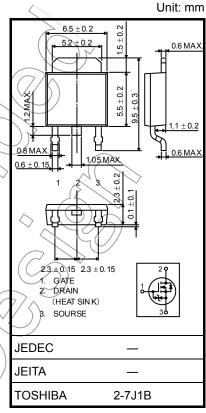
2SK4103

Switching Regulator Applications

- Low drain-source ON-resistance: R_{DS} (ON) = 1.35Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 2.8 S (typ.)
- Low leakage current: $I_{DSS} = 100 \mu A (V_{DS} = 500 V)$
- Enhancement model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	500	(Y)	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	500	($($ $($ $))$	
Gate-source voltage		V_{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	5		
	Pulse (t = 1 ms) (Note 1)	I _{DP}	20		
Drain power dissipation (Tc = 25°C)		P _D	40	W	
Single pulse avalanche energy (Note 2)		EAS	180	mJ	
Avalanche current		IAR	5	A	
Repetitive avalanche energy (Note 3)		EAR	4	mJ	
Channel temperature		(T _{ch}	150	∕\°C	
Storage temperature range		Tstg	-55 to 150	~¢	



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/ Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic Symbol	Max	Unit
Thermal resistance, channel to case Rth (ch-c)	3.125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 12.2 mH, $I_{AR} = 5 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

Electrical Characteristics (Ta = 25°C)

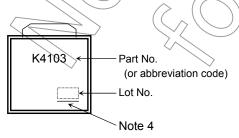
Char	racteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_		V
Drain cutoff curre	ent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source bre	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_		V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	7(4.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.0 A		1.35	1.50	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	().)	2.8		S
Input capacitance	Э	C _{iss}		_	550		
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	7		pF
Output capacitance		Coss		_	70		
Switching time	Rise time	t _r	V _{GS} O V ID = 2.5 A VOUT	-	10		
	Turn-on time	t _{on}	0 V		20) —	20
	Fall time	t _f	V _{DD ≈} 225 V	7) 10		ns
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs		50		
Total gate charge	9	Qg) —	16	_	
Gate-source cha	rge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} \neq 10 \text{ V}, I_D = 5 \text{ A}$	_	10	_	nC
Gate-drain charge Q _{gd}		Qgd			6	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	20	Α
Forward voltage (diode)	VDSF	$D_R = 5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V,	_	1400	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	9	_	μС

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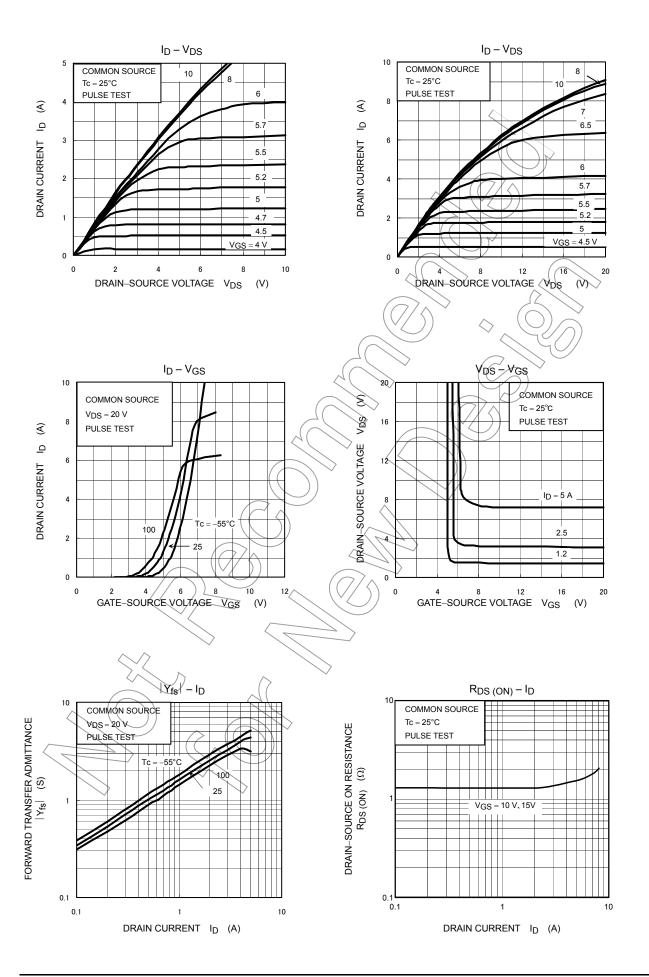




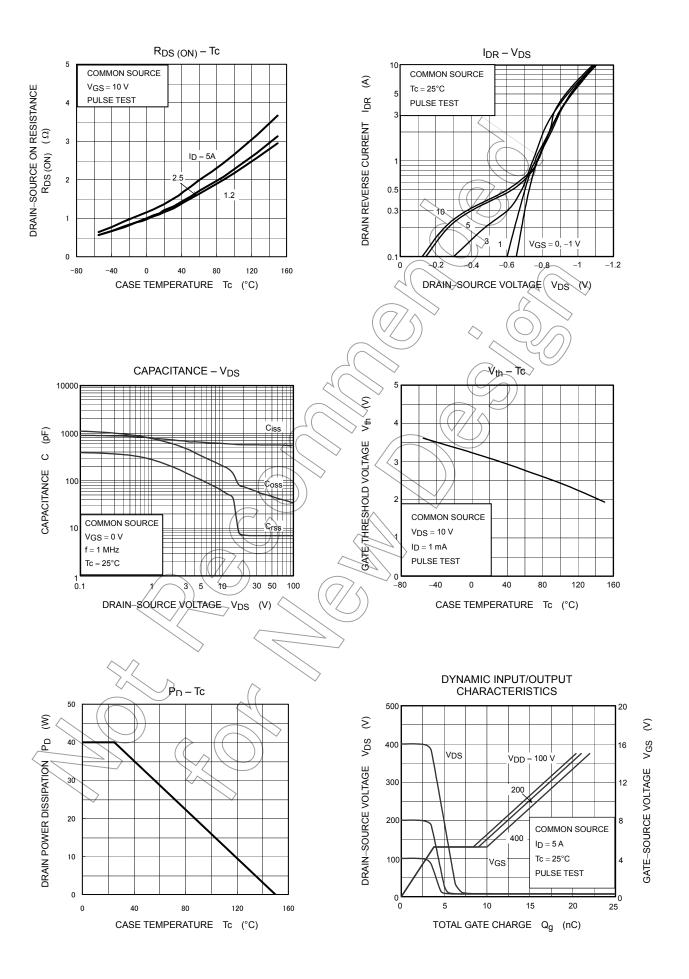
Note 4 : A line under a Lot No. identifies the indication of product Labels $\hbox{\tt [[G]]/RoHS\ COMPATIBLE\ or\ [[G]]/RoHS\ [[Pb]]}$

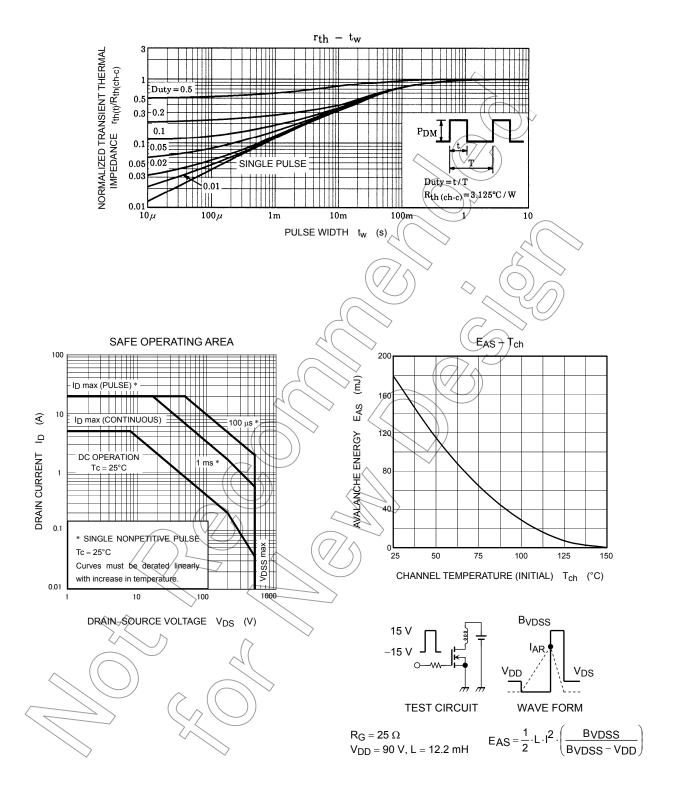
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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